

Flux Best Practices – Hand Soldering



mid Performance Solutions Business 🚃



Hand Soldering

- Best case Only use the flux in the cored wire
- If more flux is needed, your first step is to try a cored wire with a higher percentage of flux.
 - -Alpha Standard Core Wire Percentages:
 - P1 (1.1%)
 - P2 (2.2%)
 - P3 (3.3%)



Hand Soldering

- For larger assemblies and components, external preheat can help improve the soldering results by reducing the soldering contact time
- Make sure your tip size is correct.

-We recommend reviewing these areas before considering the use of a supplemental flux



Hand Soldering

- If additional, supplemental flux is needed, we recommend using a flux pen
 - This allows for tight control of where the flux gets applied to the assembly
 - Flux in squeeze bottles is not recommended



• Risk of flux going where it is not intended

Hand Soldering

- For No clean supplemental flux, use a flux that is very safe electrically
- Alpha NR-205 Flux passes SIR even in situations where flux does not experience soldering temperatures
- It includes no rosin, so residue cosmetics are very good. Low, clean, clear residues.







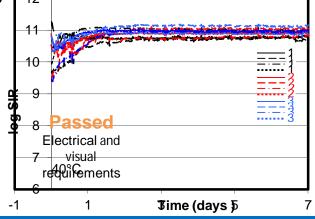
Hand Soldering

- A second option for No Clean supplemental flux is EF-6100R
- It has a higher solids content (4.3% vs. 2.5%)

– This delivers more activity for improved soldering performance with fast wetting.

It has outstanding electrical reliability/ SIR performance

-It includes a small amount of rosin,











Removing Water Soluble hand solder residues

- Flux residues need to be removed in heated DI water in your existing aqueous cleaning process
- Clean ASAP after processing







Removing No Clean hand solder residues

- Use a cleaning solvent that is designed for cleaning no clean flux residues:
 - MicroCare, Techspray, etc.
- IPA is a poor cleaning solvent:
 - The flux residue may not be easily soluble in IPA.
 - IPA evaporates very quickly.
 - Proper flux cleaner sprays tend to evaporate more slowly, giving time to absorb the cleaning media and residue solution.





Removing No Clean hand solder residues

- Place a chem wipe or similar over the area to be cleaned
- Spray the flux remover onto the wipe
- Use brush to scrub through the wipe -The wipe absorbs the cleaning media and flux residue
- Rinse using same cleaning solution
- Dry





Removing No Clean hand solder residues

Other tips:

- Routinely replace cleaning brushes to prevent contamination
- For high reliability applications, it is recommended to use an automated cleaning process with a PoR
 - Eliminates risk from operator inconsistency or improper technique



Hand Soldering - Component Removal / Replacement

- Typically supplemental flux is required to remove the component
 - For No Clean, we recommend using:
 - a safe liquid flux (NR-205 Flux Pen)
 - or a safe, no clean paste Flux, such as Alpha HF-1, universal paste flux

– HF-1 can be used for all touch up & hand soldering operations as well as BGA repair/reballing and QFN/LGA repair.

 It does <u>not</u> have to see the full thermal cycle from a typical reflow process.



Hand Soldering - Component Removal / Replacement

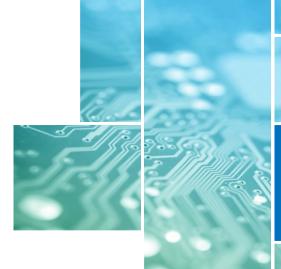
- After component removal, it is recommended to clean the area
- After hand solder replacement, the new part can either be left as a no clean or cleaned again for NC / WS

 In these cases where replacement or rework/touch up is not part of the documented PoR it is recommended that the flux residues be removed

- This will avoid any question of long term reliability



What questions do you have?







Thank you for your time and for your business

We are here to help!